

Silicon Photodiodes KPD30S

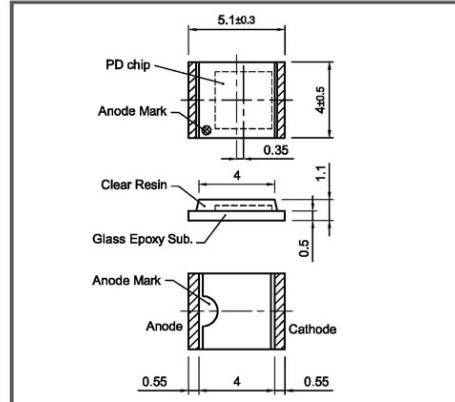
■ Features

- Transparent epoxy mold
- High sensitivity

■ Applications

- Optical switches
- Optical encoders
- Pulse detectors
- Sensors and industrial controls

Dimensions (unit: mm)



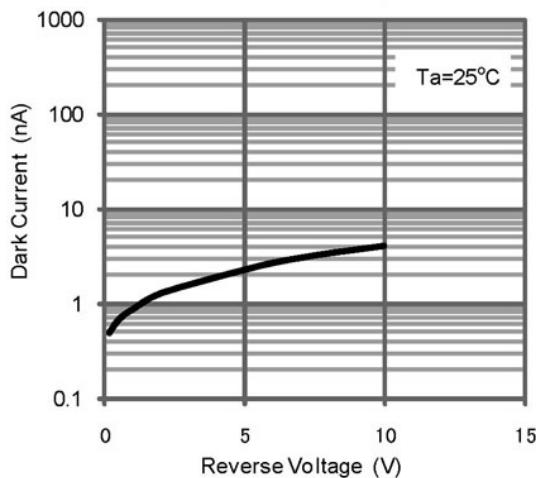
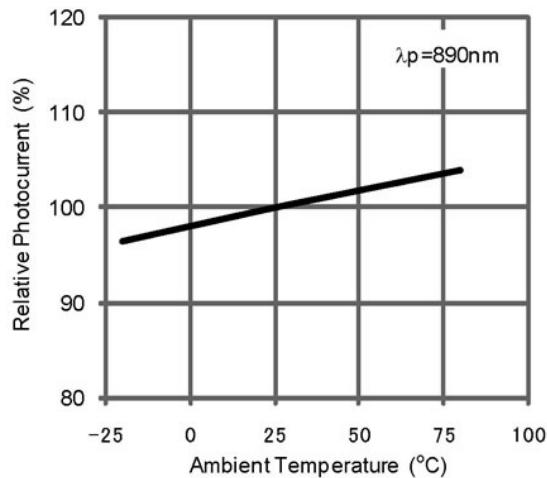
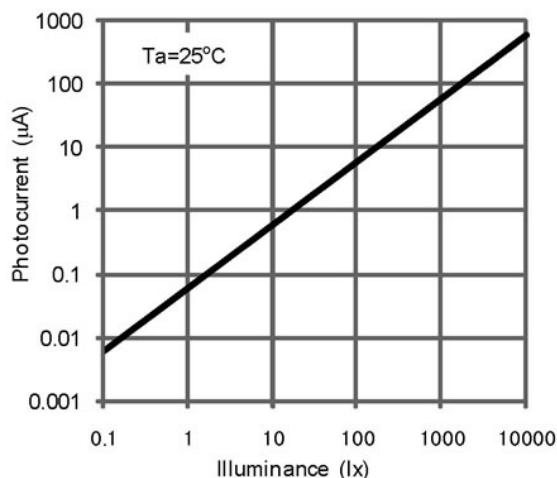
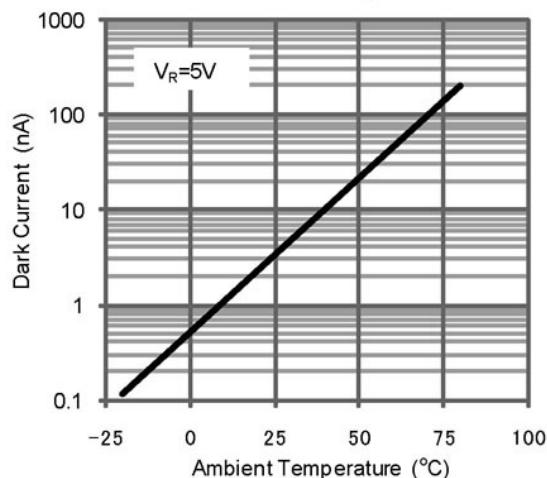
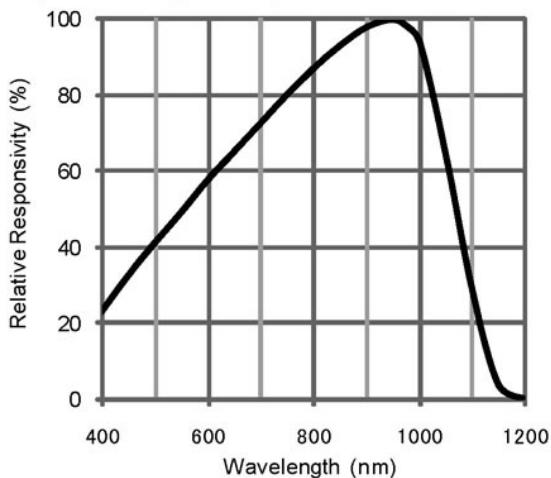
■ Specifications

● Absolute Maximum Ratings

Parameter	Symbol	Value	Unit	Conditions
Reverse voltage	V _R	5	V	
Reverse Current	I _R	1	mA	
Forward current	I _F	10	mA	
Operating temperature	T _{opr}	-20 to +80		Avoid dew condensation
Storage temperature	T _{stg}	-30 to +85		Avoid dew condensation
Soldering temperature	T _{sol}	260		Soldering time less than 3 seconds

● Electrical and Optical characteristics

Parameter	Symbol	Value			Unit	Conditions
		Min.	Typ.	Max		
Sensitive size	S		2.59x2.59		mm	
Operating voltage	V _{opr}			5	V	
Sensitive wavelength		400	950(p)	1000	nm	p=Peak wavelength
Open circuit voltage	V _{op}		350		mV	1000lx @2856k
Short Circuit Current	I _{sh}		68		µA	1000lx @2856k
Dark current	I _D			30	nA	V _R =5V
Terminal capacitance	C _t		17		pF	V _R =5V, f=1MHz
Half angle	2		120		deg	

Dark Current - Reverse Voltage

Photocurrent - Ambient Temperature

Photocurrent - Illuminance

Dark Current - Ambient Temperature

Spectral Responsivity

Directivity
